4MEGA BIT (262,144 WORD x 16BIT / 524,288 WORD x 8BIT) CMOS U.V. ERASABLE AND ELECTRICALLY PROGRAMMABLE READ ONLY MEMORY

DESCRIPTION

The TC574200D is a 4,194,304 bit CMOS ultraviolet light erasable and electrically programmable read only memory. It is organized as 256K words of 16 bit or 512K words of 8 bit. The TC574200D is compatible with 40 pin 4M bit Mask ROM. This product is packed in 40 pin standard cerdip package. The TC574200D is fabricated with the CMOS technology. circuit techniques provide both high speed and low power features with access time of 100ns/120ns The programming time of the / 150ns and a maximum operating current of 70mA / 10MHz. TC574200D except overhead times of EPROM programmer is only 28 seconds by using the high speed programming algorithm.

FEATURES

Peripheral circuit

: CMOS : NMOS Low power

Standby dissipation

• Full static operation

• Input and output TTL compatible

• Three state output

 High speed programming operation : tpw 50µs : TC534200P • 4M MROM compatible pinout

• Standard 40 pin DIP cerdip package: WDIP40-P-600B

Memory cell

• Fast access time - 10 - 120 - 150 5V ± 10% 5V ± 5% Vcc 0°C ~ 70°C Temp 100ns 120ns 150ns Tacc

-10 satisfies characteristics of -120.

Single 5V power supply

PIN CONNECTION

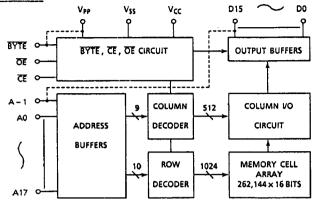
	(TOP VIE	(Refer	ence)
A17 U 1 A7 U 2 A6 U 3 A5 U 4 A4 U 5 A3 U 6 A2 U 7 A1 U 8 A0 U 9 CE U 10 V ₃₅ U 11. OE U 12 OO U 13 OB U 14 D1 U 15 D9 U 16 D2 U 17 D10 U 18 D3 U 19 D11 U 20	40 A8 39 A9 38 A10 37 A11 36 A12 35 A13 34 A14 33 A15 32 A16 31 BYTE/V _{PP} 30 V _{SS} 29 D15/A-1 28 D7 27 D14 26 D6 25 D13 24 D5 23 D12 22 D4 21 V _{CC}	A17 1 A7 1 A6 3 A5 4 A4 15 A3 16 A2 17 A1 19 GE 10 V ₅₁ 11 OE 12 OO 14 D1 15 D2 17 D10 18 D3 19 D11 20	40 A8 39 A9 38 A10 37 A11 36 A12 35 A13 34 A14 33 A15 32 A16 31 BYTE 30 V ₅₅ 29 D15/A - 1 26 D6 25 D13 24 D5 23 D12 22 D4 21 V _{6C} A10 A10
TC5742	00D		sk ROM 4200P

PIN NAMES

A0~A17	Address Input
D0~D14	Output (input)
CE	Chip Enable Input
ठह	Output Enable Input
D15/A-1	Outpdt (Input)
DISTATI	/Address Input
BYTE/Vep	Word, Byte select Input
BTIE/VPP	/Program Supply Voltage
Vcc	V _{CC} Supply Voltage
Vss	Ground

: 100µA

BLOCK DIAGRAM



MODE SELECTION

MODE	Œ	Œ	BYTE /VFP	Vcc	D0~D7	D8~D14	D15 /A-1	Power
Read (16 Bit)	L	ı	Н		Da	ta Out		
Read (Lower 8 Bit)	L	L	L		Data Out (Lower 8 Bit)	High Impedance	L	
Read (Upper 8 Bit)	L	٦	L	50	Data Out (Upper 8 Bit)	High Impedance	н	Active
Output Deselect	Γ.	н	н		Hig	h Impedance		
Output Deserect	1		L	}	Hig	h Impedance		
Cadl	н	Γ.	н]	Hiç	h Impedance		Standby
Standby	"	•	L		Hig	h Impedance	*	Standby
Program	L	Н			Da	ta In		
Program Inhibit	Н	н	12.5V	6.25V	High Impedance			Active
Program Verify	*	L			Da	ta Out		

Note: $H = V_{IH}$, $L = V_{IL}$, $* = V_{IH}$ or V_{IL}

MAXIMUM RATINGS

SYMBOL	ITEM	RATING	UNIT
V _{CC}	V _{CC} Power Supply Voltage	- 0.6~7.0	٧
V _{PP}	Program Supply Voltage	- 0.6~14.0	٧
Vin	Input Voltage	- 0.6~7.0	v
V _{IN} (A9)	Input Voltage (A9)	- 0.6~13.5	V
V1/0	Input/Output Voltage	- 0.6~V _{CC} + 0.5	V
Po	Power Dissipation	1.5	w
TSOLDER	Soldering Temperature · Time	260-10	*C · sec
T _{STRG}	Storage Temperature	- 65~150	° c
TOPR	Operating Temperature	0~70	•c

READ OPERATION

D.C. RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	TC574000D 10	TC574000D - 120 / 150
V _{IH}	Input High Voltage	2.2V~V _{CC} + 0.3	2.2V~V _{CC} +0.3
VIL	Input Low Voltage	-0.3V~0.8V	- 0.3V~0.8V
Vcc	V _{CC} Power Supply Voltage	5V ± 5%	5V ± 10%

D.C. AND OPERATING CHARACTERISTICS (Ta = 0~70°C)

SYMBOL	PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
lu	Input Current	V _{IN} = 0V~V _{CC}	-	-	± 10	μА	
		CE = 0V IOUT = 0mA f = 10MHz	-	_	70	mA	
lcco1	Operating Current	CE = 0V I _{OUT} = 0mA f = 8.3MHz	-	-	60	mA	
Icco2	<u> </u>	CE = 0V IOUT = 0mA f = 1MHz	-		30	mA	
lccs1		CE = V _{IH}	-	-	1	mA	
I _{CC52}	Standby Current	CE = V _{CC} - 0.2V	-	-	100	μΑ	
V _{OH}	Output High Voltage	I _{OH} = ~ 400µA	2.4	-		V	
VoL	Output Low Voltage	I _{OL} = 2.1mA	-		0.4	v	
J _{PP1}	V _{PP} Current	V _{PP} = 0V~V _{CC} + 0.6V	-	_	± 10	μА	
ILO	Output Leakage Current	V _{OUT} = 0.4V~V _{CC}	-	_	± 10	μА	

A.C. CHARACTERISTICS ($Ta = 0 \sim 70^{\circ}C$)

		_	10	- 120		- 150		UNIT	
SYMBOL	PARAMETER	MIN.	MAX.	MIN.	MAX.	MiN.	MAX.	01111	
t _{ACC}	Address Access Time	-	100	-	120	-	150	ns	
t _{CE}	CE to Output Valid	-	100	-	120	-	150	ns	
toe	OE to Output Valid	-	50	-	60		70	ns	
tori	CE to Output in High Impedance	0	50	0	50	0	60	ns	
t _{DF2}	OE to Output in High Impedance	0	50	0	50	0	60	ns	
tон	Output Data Hold Time	0	-	0		0		ns	
t _{BT}	BYTE to Output Valid	-	100	-	120		150	ns	
tato	BYTE to Output in High Impedance	7-	60	-	60	-	70	ns	

TC574200D-10 satisfies characteristics of TC574200D-120.

A.C. TEST CONDITIONS

• Output Load : 1 TTL Gate and CL = 100PF

· Input Pulse Rise and Fall Time : 10ns Max

- Input Pulse Levels : 0.45V and 2.4V

• Timing Measurement Reference Level : Input 0.8V and 2.2V, Output 0.8V and 2.0V

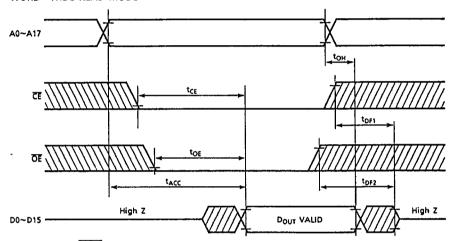
CAPACITANCE * (Ta = 25°C, f = 1MHz)

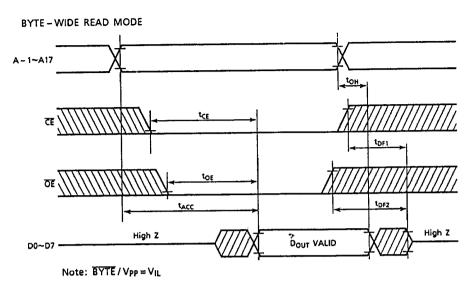
SYMBOL	PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
C _{IN1}	Input Capacitance	V _{IN} = 0V	-	6	10	₽F
C _{IN2}	Input Capacitance (BYTE/Vpp)	V _{IN} = 0V	-	110	120	pF
Cout	Output Capacitance	V _{OUT} = 0V	-	10	12	ρF

^{*} This parameter is periodically sampled and is not 100% tested.

TIMING WAVEFORMS

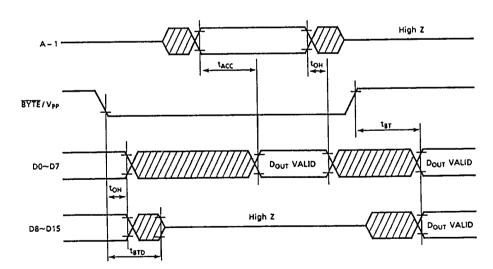
WORD-WIDE READ MODE





BYTE TRANSITION

A0-5A17



Note: \overline{CE} , $\overline{OE} = V_{iL}$

HIGH SPEED PROGRAM OPERATION

D.C. RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER MIN		TYP.	MAX.	UNIT	
ViH	Input High Voltage	2.2	-	V _{CC} + 1.0	v	
VIL	Input Low Voltage	- 0.3	-	0.8	٧	
Vcc	V _{CC} Power Supply Voltage	6.00	6.25	6.50	٧	
Vpp	V _{PP} Power Supply Voltage	12.20	12.50	12.80	v	

D.C. AND OPERATING CHARACTERISTICS ($Ta = 25 \pm 5$ °C, $V_{CC} = 6.25 \pm 0.25$ V, $V_{PP} = 12.50 \pm 0.30$ V)

SYMBOL	PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
lu	Input Current	V _{IN} = 0V~V _{CC}	-	-	± 10	μА
V _{OH}	Output High Voltage	I _{OH} = 400µA	2.4	_	_	v
V _{OL}	Output Low Voltage	I _{OL} = 2.1mA	-	_	0.4	v
lcc	V _{CC} Supply Current	-	-	-	40	mA
Ipp2	V _{PP} Supply Current	V _{PP} = 12.8V	_	-	50	mA

A.C. PROGRAMMING CHARACTERISTICS ($Ta = 25 \pm 5$ °C, $V_{CC} = 6.25 \pm 0.25$ V, $V_{PP} = 12.50 \pm 0.30$ V)

SYMBOL	PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
t _{AS}	Address Setup Time	-	2	-	_	μs
t _{AH}	Address Hold Time	-	2	-	-	μs
t _{CES}	CE Setup Time	-	0	-	-	μs
t _{CEH}	CE Hold Time	-	0	-	-	μ5
t _{OES}	OE Setup Time	-	2	-	-	μs
tos	Data Setup Time	-	2	-	-	μs
t _{OH}	Data Hold Time	-	2	-	-	μς
t _{VPS}	V _{PP} Setup Time	_	2	-	-	μs
t _{vcs}	V _{CC} Setup Time	-	2	-	_	μs
t _{PW}	Program Pulse Width	- ,	45	50	55	μs
topw	Overprogram Pulse Width	Note 1	45	50	55	μs
t _{OE}	OE to Output Valid	Œ=V _{IH}	-	-	100	ns
topp	OE to Output in High Impedance	ČE = VIH	_	-	90	ns

A.C. TEST CONDITIONS

· Output Load

: 1 TTL Gate and CL = 100PF

· Input Pulse Rise and Fall Time

: 10ns Max

· Input Pulse Levels

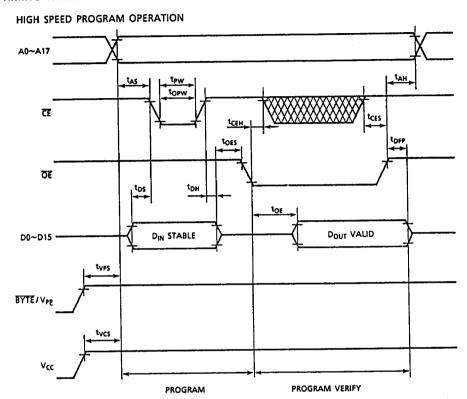
: 0.45V and 2.4V

· Timing Measurement Reference Level

: Input 0.8V and 2.2V, Output 0.8V and 2.0V

Note 1: topw depends on the program pulse width which is required in the initial program.

TIMING WAVEFORMS



- Note: 1. VCC must be applied simultaneously or before Vpp and cut off simultaneously or after Vpp.
 - 2. Removing the device from socket and setting the device in socket with Vpp=12.50V may cause permanent damage to the device.
 - 3. The Vpp supply voltage is permitted up to 14V for program operation. So the voltage over 14V should not be applied to the Vpp terminal. When the switching pulse voltage is applied to the Vpp terminal, the overshoot voltage of its pulse should not be exceeded 14V.



TC574200D-10, TC574200D-120 TC574200D-150

ERASURE CHARACTERISTICS

The TC574200D's erasure is achieved by applying shortwave ultraviolet light which has a wavelength of 2537Å (Angstroms) to the chip through the transparent window. Then integrated dose (ultraviolet light intensity [W/cm²] × exposure time [sec.]) for erasure should be a minimum of 15 [W·sec/cm²].

When the Toshiba sterilizing lamp GL-15 is used and the device is exposed at a distance of 1cm from the lamp surface, the erasure will be achieved within 60 minutes. And using commercial lamps whose ultraviolet light intensity is a 12000 [μ W/cm²] will reduce the exposure time to about 20 minutes. (In this case, the integrated dose is 12000 [μ W/cm²] × (20×60) [sec]=15 [W·sec/cm²].)

The TC574200D's erasure begins to occur when exposed to light with wavelength shorter than 4000Å. The sunlight and the fluorescent lamps will include 3000~4000Å wavelength components. Therefore when used under such lighting for extended periods of time, the opaque seals—Toshiba EPROM Protect Seal AC907—are available.

OPERATION INFORMATION

The TC574200D's eight operation mode are listed in the following table. Mode selection can be achieved by applying TTL level signal to all inputs.

MODE	Œ	Œ	BYTE /Vpp	Vcc	D0~D7	D8~D14	D15 /A-1	Power
Read (16 Bit)	L	L	Н		Da	ta Out		
Read (Lower 8 Bit)	L	L	L		Data Out (Lower 8 Bit)	High Impedance	L	
Read (Upper 8 Bit)	٦	L	L	5V	Data Out (Upper 8 Bit)	High Impedance	Н	Active
Output Deselect		н	Н	}	Hiç	gh Impedance		
Output Deserect			L		Hig	gh Impedance	•	
Standby	Н		н	}	Hig	gh Impedance		Standby
Standby		_	L		Hig	gh Impedance	•	Standby
Program	ı	Н			Da	ta In		
Program Inhibit	Н	н	12.5V	6.25V	Hiç	gh Impedance		Active
Program Verify	•	L			Da	ta Out		

Note: H=VIH, L=VIL +=VIH or VIL

READ MODE

The TC574200D has the BYTE/Vpp terminal that selects word-wide output and byte-wide output. When BYTE/Vpp is set to V_{IH}, the word-wide output is selected, and D15/A-1 pin is used for D15 data output.

When BYTE/Vpp is set to V_{IL}, the byte-wide output is selected, and D15/A-1 pin is used for A-1 address input. When A-1 is set to V_{IL} in this condition, the data output is selected lower 8 bits of the 16 bit data which has been programmed. When A-1 is set to V_{IH}, the data output is selected upper 8 bits.

The TC574200D has two control function. The chip enable (\overline{CE}) controls the operation power and should be used for device selection. The output enable (\overline{OE}) controls the output buffers, independent of device selection. Assuming that $\overline{CE} = \overline{OE} = V_{IL}$, the output data is valid at the outputs after address access time from stabilizing of all addresses. The \overline{CE} to output valid (tCE) is equal to the address access time (tACC). Assuming that $\overline{CE} = V_{IL}$ and all addresses are valid, the output data is valid at the outputs after tOE from the falling edge of \overline{OE} .

OUTPUT DESELECT MODE

Assuming that $\overline{CE}=V_{IH}$ or $\overline{OE}=V_{IH}$, the outputs will be in a high impedance state. So two or more TC574200D's can be connected together on a common bus line. When \overline{CE} is decoded for device selection, all deselected devices are in low power standby mode.

STANDBY MODE

The TC574200D has a low power standby mode controlled by the CE signal. By applying a high level to the CE input, the TC574200D is placed in the standby mode which reduces the operating current to 100µA by applying MOS - high level (VCC) and then the outputs are in a high impedance state, independent of the OE input.



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PROGRAM MODE

Initially, when recieved by customers, all bits of the TC574200D are in the "1" state which is erased state. Therefore the program operation is to introduce "0's" data into the desired bit location by electrically programming. The TC574200D is in the programming mode when the Vpp input is at 12.50V and \overline{CE} is at TTL-Low under \overline{OE} =VIH. Data to be programmed must be applied 16 bits in parallel to the data pins.

The TC574200D can be programmed any location at anytime either individually, sequentially, or at random.

PROGRAM VERIFY MODE

The verify mode is to check that desired data is correctly programmed on the programmed bits. The verify is accomplished with \overline{OE} at V_{IL} . The programmed data should be compared with the original word-wide (16 bit) data.

PROGRAM INHIBIT MODE

Under the condition that the program voltage (12.50V) is applied to Vpp terminal, a high level $\overline{\text{CE}}$ input inhibits the TC574200D from being programmed. Programming of two or more EPROMs in parallel with different data is easily accomplished. That is, all inputs except for $\overline{\text{CE}}$ and $\overline{\text{OE}}$ may be commonly connected, and a TTL low level program pulse is applied to the $\overline{\text{CE}}$ of the desired device only and TTL high level signal is applied to the other devices.

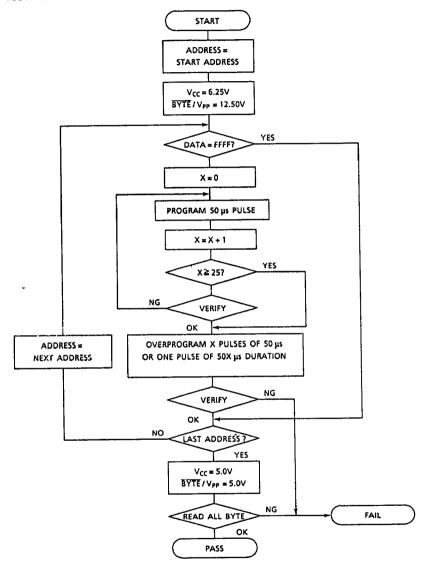
HIGH SPEED PROGRAM MODE

The device is set up the high speed programming mode when the programming voltage (12.50V) is applied to the Vpp terminal with $V_{CC}=6.25V$. The programming is achieved by applying a single TTL low level 50 μ s pulse to the \overline{CE} input after addresses and data are stable. Then the programmed data is verified by using Program Verify Mode. If the programmed data is not correct, another program pulse of 50 μ s is applied and then the programmed data is verified. This should be repeated until the program operates correctly(max. 25 times).

After correctly programming the selected address, the overprogram pulse of same length that needed for initial programming should be applied. When programming has been completed, the data in all addresses should be verified with $V_{CC} = V_{PP} = 5V$.

HIGH SPEED PROGRAM MODE

FLOW CHART



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ELECTRIC SIGNATURE MODE

Electric signature mode allows to read out a code from TC574200D which identifies its manufacturer and device type. The programming equipment may read out manufacturer code and device code from TC574200D by using this mode before program operation and automatically set program voltage (Vpp) and algorithm.

Electric signature mode is set up when 12V is applied to address line A9 and the rest of address lines is set to V_{IL} in read operation. Data output in this condition is manufacturer code. Device code is identified when address A0 is set to V_{IH} . These two codes possess an odd parity with the parity bit of (D7).

The following table shows electric signature of TC574200D.

SIGNATURE	A0	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	HEX DATA
Manufacturer Code	V _{IL}	*	•	*	•	*	*	*	٠,,	1	0	0	1	1	٥	0	0	**98
Device Code	VIH	*	*	•	•	*	•	*	٠	1	0	0	0	1	1	1	1	**8F

Note: A1 – A8, A10 – A17, \overline{CE} , \overline{OE} = V_{1L}

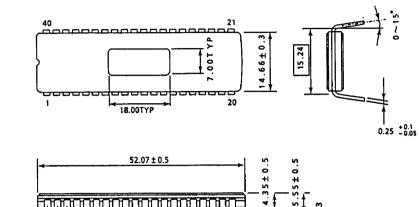
BYTE / VPP = V_{IH}
* Don't care

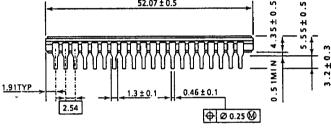
D.C. RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
Vcc	V _{CC} Power Supply Voltage	4.50	5.00	5.50	٧
V _{ID}	A9 Auto Select Voltage	11.50	12.00	12.50	v

OUTLINE DRAWINGS

Unit in mm





Weight: 12.20g (TYP.)